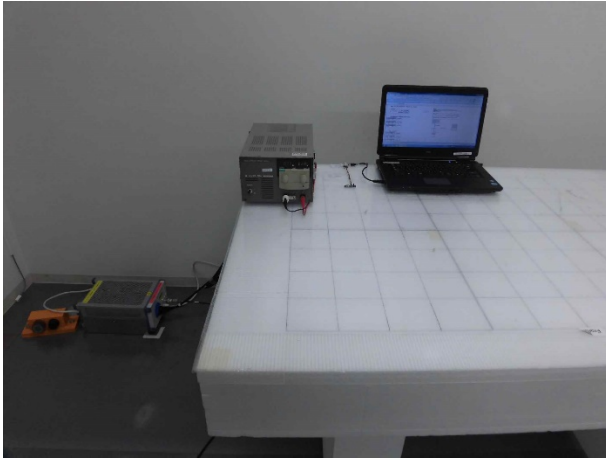


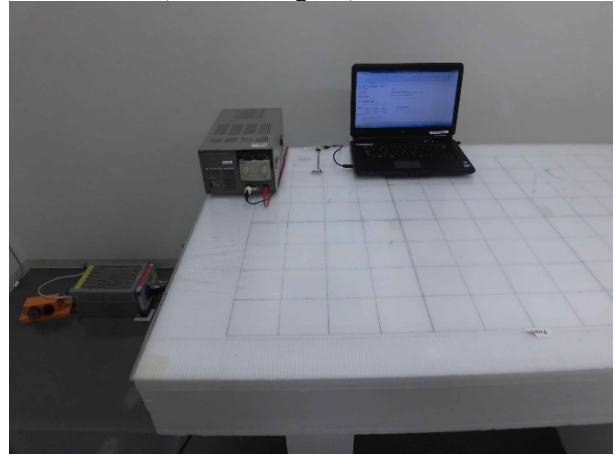
APPENDIX 3: Photographs of test setup

Conducted Emission

BT LE

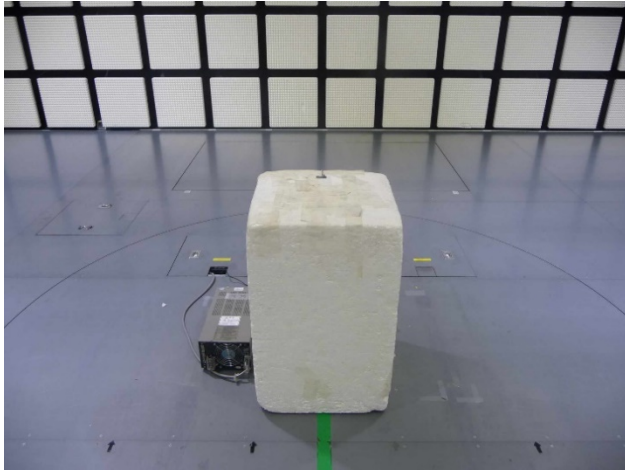


ANT, Nordic Original, IEEE802.15.4

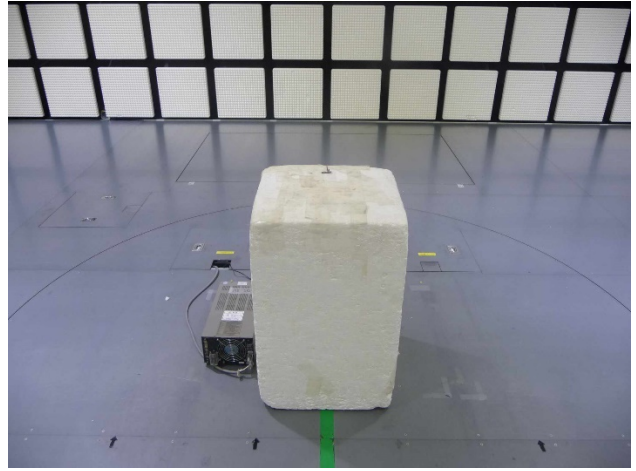


Radiated Spurious Emission

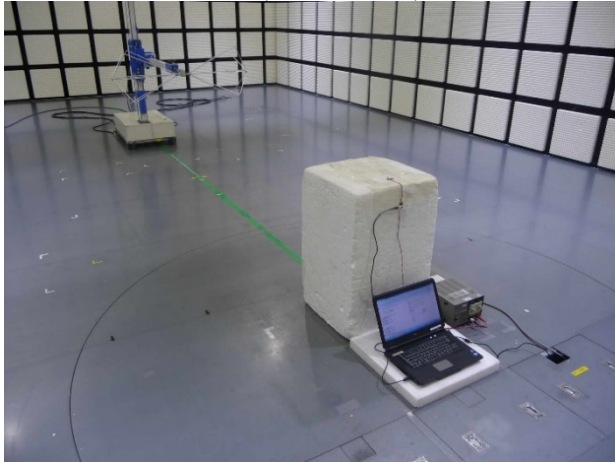
BT LE
Front



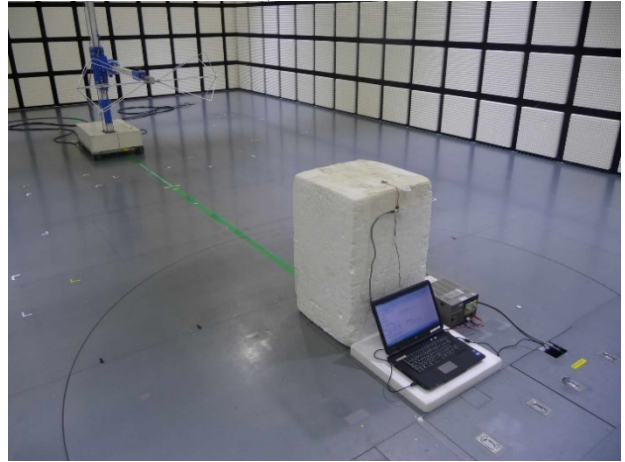
ANT, Nordic Original, IEEE802.15.4
Front



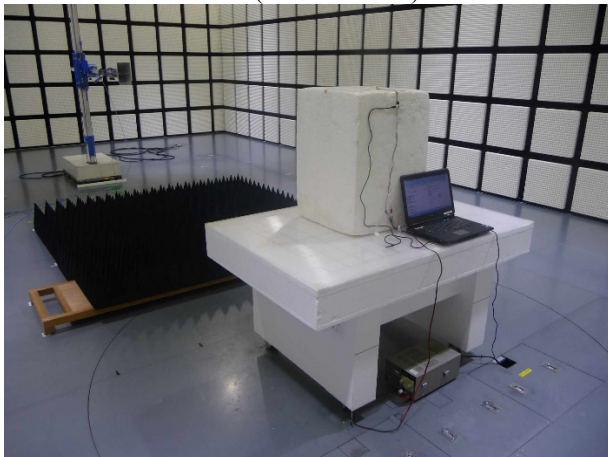
Rear (Below 1 GHz)



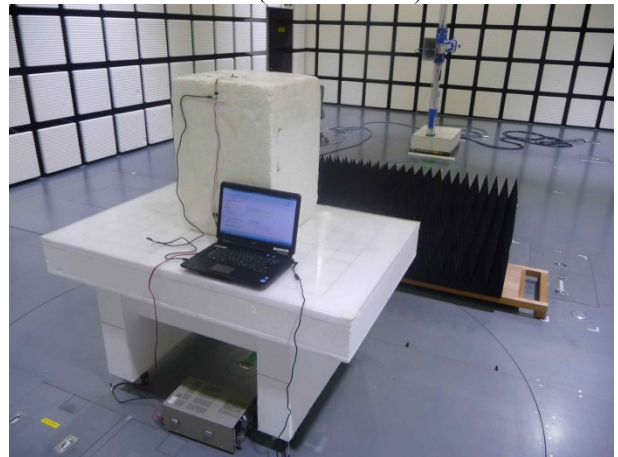
Rear (Below 1 GHz)



Rear (Above 1 GHz)

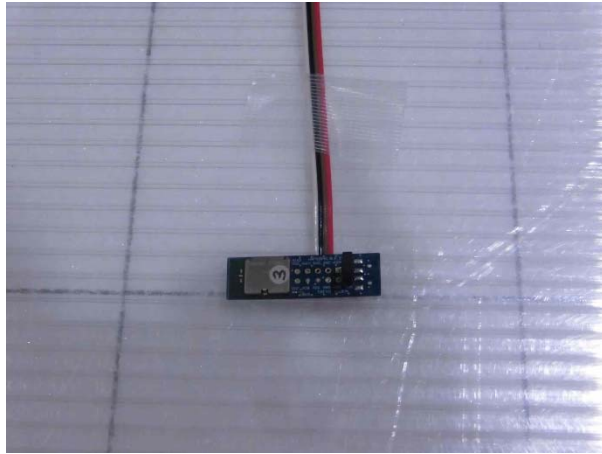


Rear (Above 1 GHz)

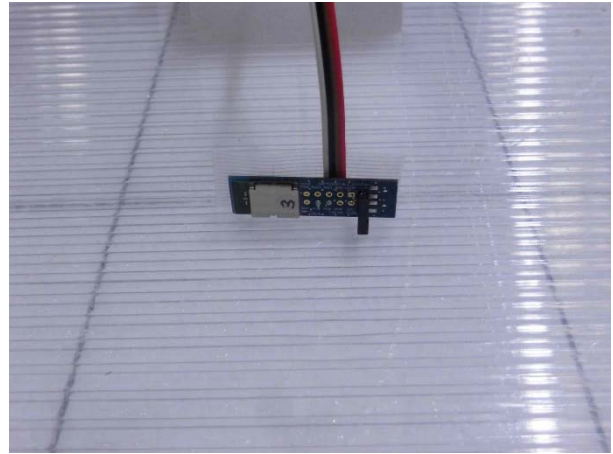


Worst Case Position

X-axis



Y-axis



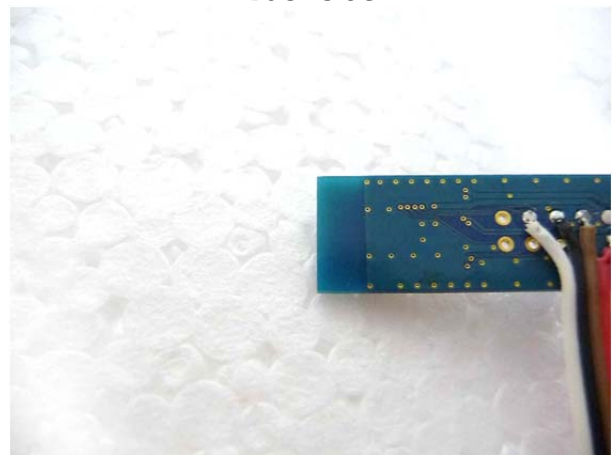
Z-axis



Upper side



Back side



*Use the motherboard with no metal plate, therefore this motherboard does not affect the module test condition.

End of Report

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